

## **TECHNICAL BULLETIN**

FAM-A-0063-A

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## Change in Packaging for the FX5UJ CPU Modules

Date of Issue
January 2023
Relevant Models
FX5UJ-24MR/ES, FX5UJ-24MT/ES, FX5UJ-24MT/ESS, FX5UJ-40MR/ES, FX5UJ-40MT/ES, FX5UJ-40MT/ESS, FX5UJ-60MT/ESS, FX5UJ-60MT/ESS

Thank you for your continued support of Mitsubishi Electric micro programmable controllers, MELSEC iQ-F series. This technical bulletin informs you that packaging for the MELSEC iQ-F series FX5UJ CPU modules will be changed. There is no impact on the general specifications, performance specifications, functions, and external dimensions of the base units due to the change.

#### 1 RELEVANT MODELS

Product	Model
FX5UJ CPU module	FX5UJ-24MR/ES, FX5UJ-24MT/ES, FX5UJ-24MT/ESS, FX5UJ-40MR/ES, FX5UJ-40MT/ES, FX5UJ-40MT/ESS, FX5UJ-60MR/ ES, FX5UJ-60MT/ES, FX5UJ-60MT/ESS

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#### 2 DETAILS ON THE CHANGE

The form of the packaging box is changed as follows to remove molded pulp buffer materials and polyethylene bags.



## **3 REASON FOR THE CHANGE**

As environmental management (ISO 14401), cardboard is used as buffer materials to reduce environmental burden.

#### 4 SCHEDULE

The change will be applied to products manufactured on and after February 2023.

Note that, depending on stock status, both products with packaging before and after change may be distributed in the market around that time.

We appreciate your kind understanding.

#### REVISIONS

Version	Date of Issue	Revision
A	January 2023	First edition

#### TRADEMARKS

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